GIULIANO SISTO in







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ABOUT ME

I am an enthusiastic SoC Researcher, with Physical Design expertise and a keen eye for design methodologies. I thrive in contexts where "what?" is always followed by "how?". Currently, I am looking for a chance to boost my knowledge on Computer Architectures while leveraging my expertise in SoC design. My ambition is to steer the semiconductor industry towards the path of Architecture-Design Co-Optimization, as I strongly believe that it will be a key enabler for next generation digital ICs.

EDUCATION

Doctor of Philosophy (PhD), Electrical Engineering

Ecole polytechnique de Bruxelles – Université Libre de Bruxelles

- Oct 2018 Oct 2021(expected)
- Leuven, BE
- Thesis: "Design Enablement of integrated circuts using sub-5nm technology process and 3D integration"
- Guest lecturer ETH Zurich, Politecnico di Bari

Exchange Student, Electronic Systems

Department of Electrical Engineering – Technology University of Eindhoven

- **i** Feb 2017 July 2017
- Eindhoven, NL
- Projects: RISC microprocessor design interconnection network modelling for a multicore processor • embedded controller design for automotive (Xilinx FPGA)
 - low power RF mixer design

MSc, Electrical Engineering, Micro Electronics Systems

Dipartimento di Ingegneria Elettrica e dell'informazione – Politecnico di Bari

i Jan 2016 – Jul 2018

Bari, IT

EXPERIENCE

PhD Candidate

Cadence Design Systems - IMEC

- iii Oct 2018 Present
- Leuven, BE
- Proposal and implementation of new methods to enable advanced technologies for front-end and back-end digital IC design
- Advanced CMOS technology nodes (sub-5nm): FinFET GAAFET CFET
- 3D-IC: Face-to-Face Hybrid Bonding stacking
- Industrial design benchmarking: ARM RISC-V NVDLA
- European project technical lead for 2nm technology node research

Engineering Internship

Huawei Technologies

- **≡** Feb 2018 − Jul 2018
- Sophia-Antipolis, FR.
- Architecture design and physical implementation of digital filters for All Digital PLLs

Event organizing team

Devlounge

■ Sep 2016 − Nov 2016

Bari, IT

TECHNICAL SKILLS

TCL Bash

Linux

Verilog, VHDL Python

Git Matlab



SOFT SKILLS

Resilience | Problem solving

Project management Empathy

Affinity to learn | Team player Public Speaking/Presenting

LANGUAGES

Italian English French Dutch



AWARDS

♀ ERASMUS+ for Traineeship Scholarship

TUCEP

2018

Bari,IT

♀ ERASMUS+ Scholarship

Politecnico di Bari

2017

Bari,IT

INTERESTS

Videogames | Board/Card games eSports | Football Cinema

Travel | Music

LIST OF PUBLICATIONS

- G.Sisto, R.Chen, et al., "Design and Optimization of SRAM Macro and Logic Using Backside Interconnects at 2nm Node", IEDM 2021, San Francisco, USA
- G.Sisto et al., "IR-Drop Analysis of Hybrid Bonded 3D-ICs with Backside Power Delivery
- G.Sisto, P. Debacker, R. Chen, G. Van der Plas, R. Chou, E. Beyne, D. Milojevic, "Design enablement of fine pitch face-to-face 3D system integration using die-by-die place & route", 3DIC 2019, Sendai, Japan and μ- & n- TSVs", IITC 2021, Kyoto, Japan